&TDK Multilayer Ceramic Chip Capacitors

C1608X5R1E106M080AC



TDK item description C1608X5R1E106MT****

Applications	Commercial Grade	
Feature	General General (Up to 50V)	
Series	C1608 [EIA 0603]	
Status	Production	



	Size
Length(L)	1.60mm +0.20,-0.10mm
Width(W)	0.80mm +0.20,-0.10mm
Thickness(T)	0.80mm +0.20,-0.10mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.30mm Min.
Decommended Land Dettern (DA)	0.70mm to 1.00mm(Flow Soldering)
Recommended Land Pattern (PA)	0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PB)	0.80mm to 1.00mm(Flow Soldering)
	0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.60mm to 0.80mm(Flow Soldering)
	0.60mm to 0.80mm(Reflow Soldering)

Electrical Characteristics		
Capacitance	10µF ±20%	
Rated Voltage	25VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	10%	
Insulation Resistance (Min.)	10ΜΩ	

Other	
Soldering Method	Wave (Flow)
	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	4000pcs

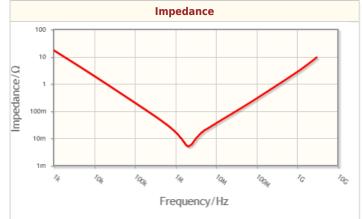
! Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

! All specifications are subject to change without notice.

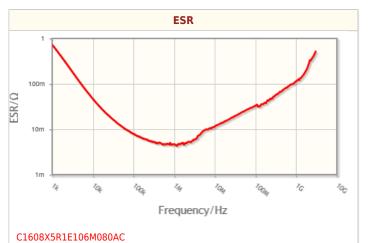
C1608X5R1E106M080AC



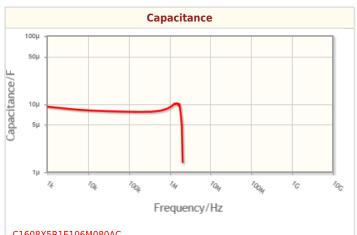


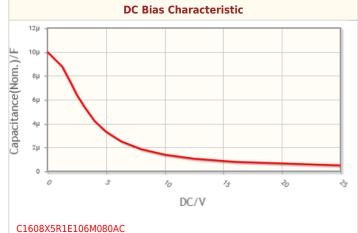


Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

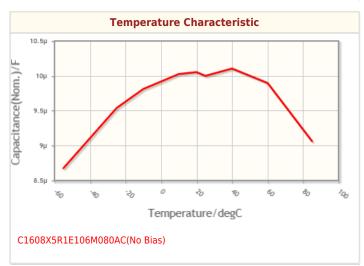


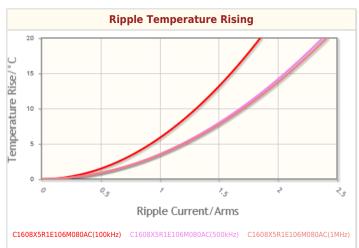
C1608X5R1E106M080AC





C1608X5R1E106M080AC





! Images are for reference only and show exemplary products.

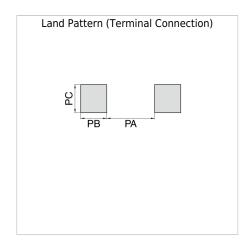
! This PDF document was created based on the data listed on the TDK Corporation website.

! All specifications are subject to change without notice.

C1608X5R1E106M080AC



Associated Images



! Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

! All specifications are subject to change without notice.